

## > Mechanical Specification:

#### (1) Dimension

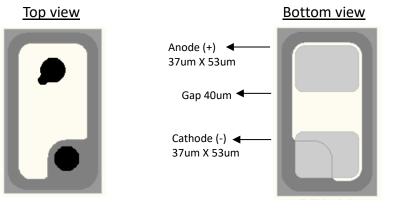
- Chip size: 4mil x 6mil (89  $\pm$  15  $\mu$ m x 150  $\pm$  15  $\mu$ m)

- Thickness: 3.1mil (80  $\pm$  10  $\mu$ m)

- Anode pad: 37  $\pm$  10  $\mu m$  x 53  $\pm$  10  $\mu m$  - Cathode pad: 37  $\pm$  10  $\mu m$  x 53  $\pm$  10  $\mu m$ 

## (2) Metallization

- Electrode pad: Au



#### **Features:**

- · High Power Density
- Low Rth and Long life time

## **Applications:**

Fine Pitch Display

# > Electro-optical Characteristics at 25°C(1):

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	Vf1	If = 10μA	1.8	-	-	V
	Vf2	If = 1mA	-	2.4	2.6	V
Reverse Current	lr	Vr = 10	-	-	0.5	uA
Dominant Wavelength <sup>(2)</sup>	λd	If = 1mA	525	-	540	nm
Spectra Half-width	Δλ	If = 1mA	-	26	-	nm
Luminous intensity <sup>(3)</sup>	lv	If = 1mA	80	-	89	- mcd
			89		98	
			98	-	108	
			108	-	119	

#### Note

<sup>(1)</sup> ESD protection during chip handling is recommended.

<sup>(2)</sup> Basically, the wavelength span is 15nm; however, customers' special requirements are also welcome.

<sup>(3)</sup> Luminous intensity is measured by EPISTAR's equipment on bare chips.

# > Absolute Maximum Ratings:

Parameter	Symbol	Condition	Rating	Unit
Forward DC Current	If	Ta = 25℃	≤ 5	mA
Reverse Voltage	Vr	Ta = 25℃	≤ 10	V
Junction Temperature	Tj	-	≤ 115	Ĉ
	Tstg	Chip	-40 ~ +85	Ĉ
Storage Temperature		Chip-on-tape/storage	5 ~ 35	Ĉ
		Chip-on-tape/transportation	-20 ~ +65	Ĉ
Temperature during Packaging	-	-	260(<5sec)*	۲

Note: Maximum ratings are package dependent. The above maximum ratings were determined using by EPISTAR standard. Forward current and junction temperature will cause the damage of LEDs if over the absolute maximum ratings.

## > Characteristic Curves:

Fig.1 – Relative luminous Intensity vs. Forward Current

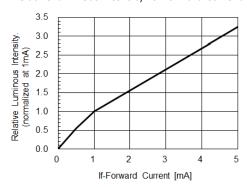


Fig.3 – Relative Intensity (@1mA) vs. Ambient Temperature

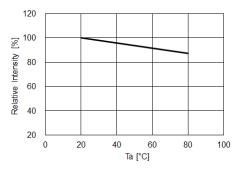


Fig.5 – Dominant Wavelength (@1mA) vs. Ambient Temperature

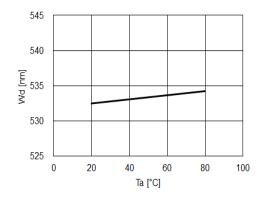


Fig.2 - Forward Current vs. Forward Voltage

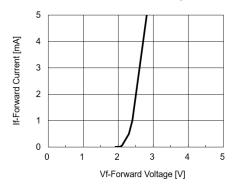


Fig.4 – Forward Voltage (@1mA) vs. Ambient Temperature

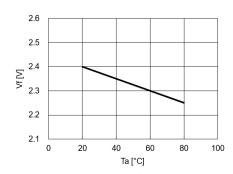
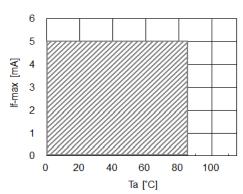


Fig.6 – Maximum Driving Forward DC Current vs. Ambient Temperature (De-rating based on Tj max. = 115°C)



<sup>\*</sup>Reflow soldering should not be done more than two times.